

# MCDN 1,5/ 3-G1-3,5 RNP26THR - PCB header



1953415

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PCB headers, nominal cross section: 1.5 mm<sup>2</sup>, color: black, nominal current: 8 A, rated voltage (III/2): 160 V, contact surface: Sn, contact connection type: Pin, number of potentials: 6, number of rows: 2, number of positions: 3, number of connections: 6, product range: MCDN 1,5/...-G1-RN-THR, pitch: 3.5 mm, mounting: THR soldering / wave soldering, pin layout: Linear pinning, solder pin [P]: 2.6 mm, number of solder pins per potential: 1, plug-in system: COMBICON FMC 1,5 - MCDN 1,5, Pin connector pattern alignment: Standard, locking: Snap-in locking, mounting method: Engagement nose, type of packaging: packed in cardboard, Article with engagement nose. The pin length is 2.6 mm. User information and design recommendations on Through Hole Reflow Technology can be found at: "Downloads"

## Your advantages

- Designed for integration into the SMT soldering process
- Intuitive locking mechanism prevents accidental disconnection
- Conductor connection on several levels enables higher contact density

## Commercial data

|                                      |                     |
|--------------------------------------|---------------------|
| Item number                          | 1953415             |
| Packing unit                         | 80 pc               |
| Minimum order quantity               | 50 pc               |
| Sales key                            | AA02                |
| Product key                          | AABTGA              |
| Catalog page                         | Page 219 (C-1-2013) |
| GTIN                                 | 4017918919443       |
| Weight per piece (including packing) | 3.07 g              |
| Weight per piece (excluding packing) | 2.42 g              |
| Customs tariff number                | 85366930            |
| Country of origin                    | DE                  |

## Technical data

### Product properties

|                           |                                            |
|---------------------------|--------------------------------------------|
| Product type              | PCB headers                                |
| Product family            | MCDN 1,5/...G1-RN-THR                      |
| Product line              | COMBICON Connectors S                      |
| Type                      | Component suitable for through hole reflow |
| Number of positions       | 3                                          |
| Pitch                     | 3.5 mm                                     |
| Number of connections     | 6                                          |
| Number of rows            | 2                                          |
| Number of potentials      | 6                                          |
| Mounting flange           | Threaded flange                            |
| Pin layout                | Linear pinning                             |
| Solder pins per potential | 1                                          |

### Electrical properties

|                             |        |
|-----------------------------|--------|
| Nominal current $I_N$       | 8 A    |
| Nominal voltage $U_N$       | 160 V  |
| Contact resistance          | 2.1 mΩ |
| Rated voltage (III/3)       | 160 V  |
| Rated surge voltage (III/3) | 2.5 kV |
| Rated voltage (III/2)       | 160 V  |
| Rated surge voltage (III/2) | 2.5 kV |
| Rated voltage (II/2)        | 250 V  |
| Rated surge voltage (II/2)  | 2.5 kV |

### Mounting

|               |                                |
|---------------|--------------------------------|
| Mounting type | THR soldering / wave soldering |
| Pin layout    | Linear pinning                 |

### Processing notes

|                                  |                       |
|----------------------------------|-----------------------|
| Process                          | Reflow/wave soldering |
| Moisture Sensitive Level         | MSL 1                 |
| Classification temperature $T_c$ | 260 °C                |
| Solder cycles in the reflow      | 3                     |

### Material specifications

#### Material data - contact

|                                        |                                                                                  |
|----------------------------------------|----------------------------------------------------------------------------------|
| Note                                   | WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/JEDEC JESD 201 |
| Contact material                       | Cu alloy                                                                         |
| Surface characteristics                | Tin-plated                                                                       |
| Metal surface contact area (top layer) | Tin (3 - 5 μm Sn)                                                                |

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|                                             |                      |
|---------------------------------------------|----------------------|
| Metal surface contact area (middle layer)   | Nickel (1 - 3 µm Ni) |
| Metal surface soldering area (top layer)    | Tin (3 - 5 µm Sn)    |
| Metal surface soldering area (middle layer) | Nickel (1 - 3 µm Ni) |

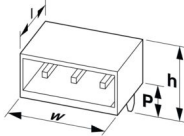
## Material data - housing

|                                        |              |
|----------------------------------------|--------------|
| Color (Housing)                        | black (9005) |
| Insulating material                    | LCP          |
| Insulating material group              | IIIa         |
| CTI according to IEC 60112             | 175          |
| Flammability rating according to UL 94 | V0           |

## Notes

|                                 |                                                                                                                                                                                 |
|---------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Details for soldering processes | Processing using reflow processes in compliance with IEC 60068-2-58 or DIN EN 61760-1 (latest version)<br>Moisture Sensitive Level (MSL) = 1 according to IPC/JEDEC J-STD-020-C |
|---------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|

## Dimensions

|                       |                                                                                      |
|-----------------------|--------------------------------------------------------------------------------------|
| Dimensional drawing   |  |
| Pitch                 | 3.5 mm                                                                               |
| Width [w]             | 14.2 mm                                                                              |
| Height [h]            | 17.8 mm                                                                              |
| Length [l]            | 13.3 mm                                                                              |
| Installed height      | 15.2 mm                                                                              |
| Solder pin length [P] | 2.6 mm                                                                               |
| Pin dimensions        | 0.8 x 0.8 mm                                                                         |

## PCB design

|               |         |
|---------------|---------|
| Pin spacing   | 3.50 mm |
| Hole diameter | 1.4 mm  |

## Mechanical tests

### Visual inspection

|               |                       |
|---------------|-----------------------|
| Specification | IEC 60512-1-1:2002-02 |
| Result        | Test passed           |

### Dimension check

|               |                       |
|---------------|-----------------------|
| Specification | IEC 60512-1-2:2002-02 |
| Result        | Test passed           |

### Resistance of inscriptions

|               |                        |
|---------------|------------------------|
| Specification | IEC 60068-2-70:1995-12 |
|---------------|------------------------|

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|                                                |                        |
|------------------------------------------------|------------------------|
| Result                                         | Test passed            |
| Polarization and coding                        |                        |
| Specification                                  | IEC 60512-13-5:2006-02 |
| Result                                         | Test passed            |
| Contact holder in insert                       |                        |
| Specification                                  | IEC 60512-15-1:2008-05 |
| Contact holder in insert<br>Requirements >20 N | Test passed            |
| Insertion and withdrawal forces                |                        |
| Result                                         | Test passed            |
| No. of cycles                                  | 25                     |
| Insertion strength per pos. approx.            | 8 N                    |
| Withdraw strength per pos. approx.             | 6 N                    |

## Electrical tests

### Thermal test | Test group C

|                            |                       |
|----------------------------|-----------------------|
| Specification              | IEC 60512-5-1:2002-02 |
| Tested number of positions | 20                    |

### Insulation resistance

|                                              |                       |
|----------------------------------------------|-----------------------|
| Specification                                | IEC 60512-3-1:2002-02 |
| Insulation resistance, neighboring positions | > 5 MΩ                |

### Air clearances and creepage distances |

|                                                        |                     |
|--------------------------------------------------------|---------------------|
| Specification                                          | IEC 60664-1:2007-04 |
| Insulating material group                              | IIIa                |
| Comparative tracking index (IEC 60112)                 | CTI 175             |
| Rated insulation voltage (III/3)                       | 160 V               |
| Rated surge voltage (III/3)                            | 2.5 kV              |
| minimum clearance value - non-homogenous field (III/3) | 1.5 mm              |
| minimum creepage distance (III/3)                      | 2.5 mm              |
| Rated insulation voltage (III/2)                       | 160 V               |
| Rated surge voltage (III/2)                            | 2.5 kV              |
| minimum clearance value - non-homogenous field (III/2) | 1.5 mm              |
| minimum creepage distance (III/2)                      | 1.6 mm              |
| Rated insulation voltage (II/2)                        | 250 V               |
| Rated surge voltage (II/2)                             | 2.5 kV              |
| minimum clearance value - non-homogenous field (II/2)  | 1.5 mm              |
| minimum creepage distance (II/2)                       | 2.5 mm              |

## Environmental and real-life conditions

### Vibration test

|               |                       |
|---------------|-----------------------|
| Specification | IEC 60068-2-6:2007-12 |
|---------------|-----------------------|

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|                        |                             |
|------------------------|-----------------------------|
| Frequency              | 10 - 150 - 10 Hz            |
| Sweep speed            | 1 octave/min                |
| Amplitude              | 0.35 mm (10 Hz ... 60.1 Hz) |
| Acceleration           | 5g (60.1 Hz ... 150 Hz)     |
| Test duration per axis | 2.5 h                       |
| Test directions        | X-, Y- and Z-axis           |

## Durability test

|                                              |                       |
|----------------------------------------------|-----------------------|
| Specification                                | IEC 60512-9-1:2010-03 |
| Impulse withstand voltage at sea level       | 2.95 kV               |
| Contact resistance R <sub>1</sub>            | 2.1 mΩ                |
| Contact resistance R <sub>2</sub>            | 2.4 mΩ                |
| Insertion/withdrawal cycles                  | 25                    |
| Insulation resistance, neighboring positions | > 5 MΩ                |

## Climatic test

|                                   |                                                                           |
|-----------------------------------|---------------------------------------------------------------------------|
| Specification                     | ISO 6988:1985-02                                                          |
| Corrosive stress                  | 0.2 dm <sup>3</sup> SO <sub>2</sub> on 300 dm <sup>3</sup> /40 °C/1 cycle |
| Thermal stress                    | 100 °C/168 h                                                              |
| Power-frequency withstand voltage | 1.39 kV                                                                   |

## Ambient conditions

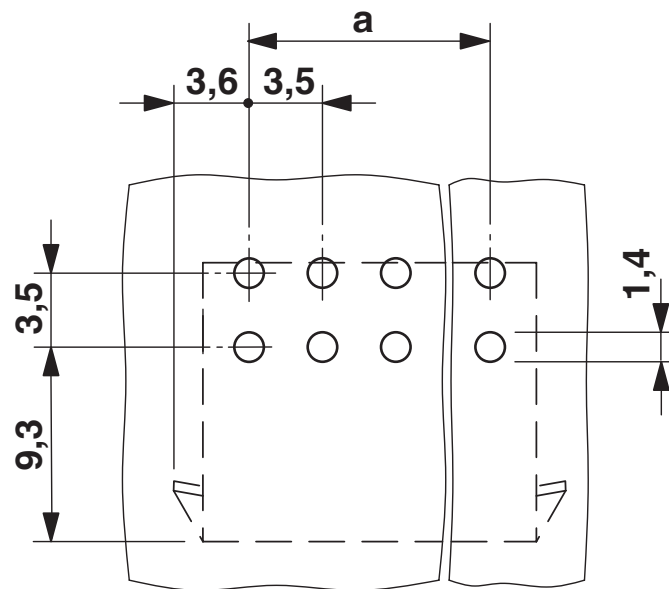
|                                         |                                                     |
|-----------------------------------------|-----------------------------------------------------|
| Ambient temperature (operation)         | -40 °C ... 100 °C (dependent on the derating curve) |
| Ambient temperature (storage/transport) | -40 °C ... 70 °C                                    |
| Relative humidity (storage/transport)   | 30 % ... 70 %                                       |
| Ambient temperature (assembly)          | -5 °C ... 100 °C                                    |

## Packaging specifications

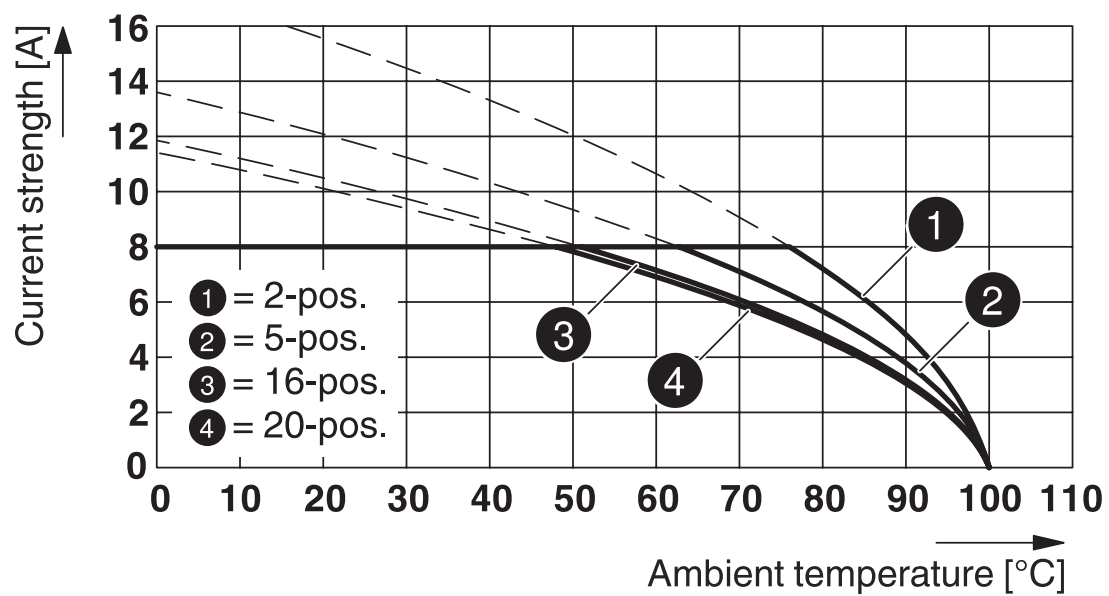
|                   |                     |
|-------------------|---------------------|
| Type of packaging | packed in cardboard |
|-------------------|---------------------|

## Drawings

Drilling plan/solder pad geometry



Diagram



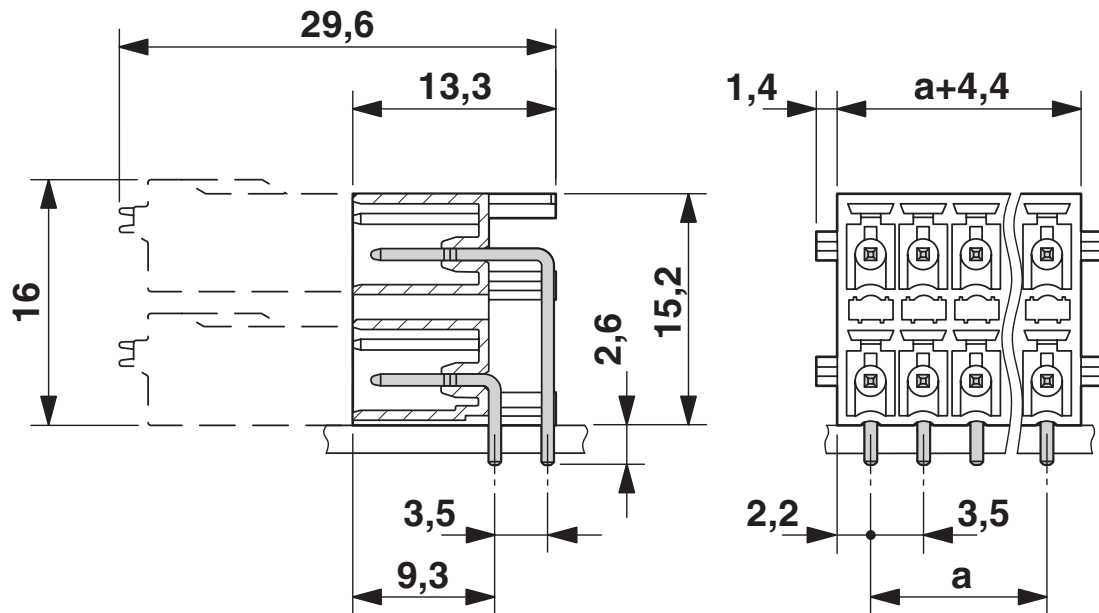
Type: FMC 1,5/...-ST-3,5-RF with MCDN 1,5/...-G1-3,5 RNP..THR

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Dimensional drawing



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## Approvals

To download certificates, visit the product detail page: <https://www.phoenixcontact.com/us/products/1953415>

|  <b>cULus Recognized</b><br>Approval ID: E60425-20110128 |                       |                       |                   |                             |
|-------------------------------------------------------------------------------------------------------------------------------------------|-----------------------|-----------------------|-------------------|-----------------------------|
|                                                                                                                                           | Nominal voltage $U_N$ | Nominal current $I_N$ | Cross section AWG | Cross section $\text{mm}^2$ |
| Use group B                                                                                                                               | 150 V                 | 8 A                   | -                 | -                           |
| Use group D                                                                                                                               | 150 V                 | 8 A                   | -                 | -                           |

|  <b>VDE approval of drawings</b><br>Approval ID: 40011723 |                       |                       |                   |                             |
|--------------------------------------------------------------------------------------------------------------------------------------------|-----------------------|-----------------------|-------------------|-----------------------------|
|                                                                                                                                            | Nominal voltage $U_N$ | Nominal current $I_N$ | Cross section AWG | Cross section $\text{mm}^2$ |
|                                                                                                                                            | 160 V                 | 8 A                   | -                 | -                           |



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## Classifications

### ECLASS

|             |          |
|-------------|----------|
| ECLASS-11.0 | 27460201 |
| ECLASS-12.0 | 27460201 |
| ECLASS-13.0 | 27460201 |

### ETIM

|          |          |
|----------|----------|
| ETIM 9.0 | EC002637 |
|----------|----------|

### UNSPSC

|             |          |
|-------------|----------|
| UNSPSC 21.0 | 39121400 |
|-------------|----------|

Environmental product compliance

|                                         |                                          |
|-----------------------------------------|------------------------------------------|
| EU RoHS                                 |                                          |
| Fulfills EU RoHS substance requirements | Yes, No exemptions                       |
| China RoHS                              |                                          |
| Environment friendly use period (EFUP)  | EFUP-E                                   |
|                                         | No hazardous substances above the limits |
| EU REACH SVHC                           |                                          |
| REACH candidate substance (CAS No.)     | No substance above 0.1 wt%               |
| EF3.0 Climate Change                    |                                          |
| CO2e kg                                 | 0.033 kg CO2e                            |